

# **STC MCR100-8 Sensitive Gate Silicon Controlled Rectifier**

# **Reverse Blocking Thyristor**

PNPN device designed for line-powered general purpose applications such as relay and lamp drivers, small motor controls, gate drivers for larger thyristors, and sensing and detection circuits. Supplied in a cost effective plastic TO-92 package.

- Sensitive Gate Allows Direct Triggering by Microcontrollers and Other Logic Circuits
- On–State Current Rating of 0.8 Amperes RMS at 80°C
- Surge Current Capability 10 Amperes
- Immunity to dV/dt 20 V/µsec Minimum at 110°C
- Glass-Passivated Surface for Reliability and Uniformity
- Blocking Voltage to 600 Volts

#### **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage (Note 1.) (T <sub>J</sub> = -40 to 110°C, Sine Wave, 50 to 60 Hz; Gate Open)	V <sub>DRM,</sub> V <sub>RRM</sub>	600	Volts
On-State RMS Current (T <sub>C</sub> = 80°C) 180° Conduction Angles	I <sub>T(RMS)</sub>	8.0	Amp
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, T <sub>J</sub> = 25°C)	I <sub>TSM</sub>	10	Amps
Circuit Fusing Consideration (t = 10 ms)	l <sup>2</sup> t	0.415	A <sup>2</sup> s
Forward Peak Gate Power (T <sub>A</sub> = 25°C, Pulse Width ≤ 1.0 μs)	P <sub>GM</sub>	0.1	Watt
Forward Average Gate Power (T <sub>A</sub> = 25°C, t = 20 ms)	P <sub>G(AV)</sub>	0.10	Watt
Forward Peak Gate Current $(T_A = 25^{\circ}C, \text{ Pulse Width } \leq 1.0 \mu\text{s})$	I <sub>GM</sub>	1.0	Amp
Reverse Peak Gate Voltage $(T_A = 25^{\circ}C, \text{ Pulse Width } \leq 1.0 \mu\text{s})$	$V_{GRM}$	5.0	Volts
Operating Junction Temperature Range @ Rate V <sub>RRM</sub> and V <sub>DRM</sub>	TJ	-40 to 110	°C
Storage Temperature Range	T <sub>stg</sub>	–40 to 150	°C

(1)  $V_{\mbox{DRM}}$  and  $V_{\mbox{RRM}}$  for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant source such that the voltage ratings of the devices are exceeded.

# SCR 0.8 AMPERES RMS 600 VOLTS





TO-92 (TO-226) **CASE 029** STYLE 10

PIN ASSIGNMENT		
1	Cathode	
2	Gate	
3	Anode	

# MCR100-8

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance – Junction to Case – Junction to Ambient	$R_{ hetaJC} \ R_{ hetaJA}$	75 200	°C/W
Lead Solder Temperature (<1/16" from case, 10 secs max)	T <sub>L</sub>	260	°C

# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

ELECTRICAL CHARACTERISTICS (T <sub>C</sub> = 25°C un	iess otherwise noted	1)	_			
Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Peak Repetitive Forward or Reverse Blocking Current (Note 1.) ( $V_D$ = Rated $V_{DRM}$ and $V_{RRM}$ ; $R_{GK}$ = 1.0 $k\Omega$ )	T <sub>C</sub> = 25°C T <sub>C</sub> = 110°C	I <sub>DRM</sub> , I <sub>RRM</sub>	_ _	_ _	10 0.1	μA mA
ON CHARACTERISTICS			_			
Peak Forward On–State Voltage <sup>(*)</sup> (I <sub>TM</sub> = 1.0 Amp Peak @ T <sub>A</sub> = 25°C)		V <sub>TM</sub>	_	_	1.7	Volts
Gate Trigger Current (Continuous dc) (Note 2.) (V <sub>AK</sub> = 12 V, R <sub>L</sub> = 100 Ohms)	$T_C = 25^{\circ}C$	I <sub>GT</sub>	-	6	8	μА
Holding Current (Note 2.) (V <sub>AK</sub> = 12 V, I <sub>GT</sub> = 0.5 mA)	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	Ін	-	0.5 -	5.0 10	mA
Latch Current $(V_{AK} = 12 \text{ V}, I_{GT} = 0.5 \text{ mA}, R_{GK} = 1.0 \text{ k})$	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	44.6	/h -	0.6 -	10 15	mA
Gate Trigger Voltage (Continuous dc) (Note 2.) (V <sub>AK</sub> = 12 V, R <sub>L</sub> = 100 Ohms, I <sub>GT</sub> = 10 mA)	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	V <sub>GT</sub>	C.	0.62 -	0.8 1.2	Volts
DYNAMIC CHARACTERISTICS		~ O''				
Critical Rate of Rise of Off–State Voltage ( $V_D$ = Rated $V_{DRM}$ , Exponential Waveform, $R_{GK}$ = 10 $T_J$ = 110°C)	000 Ohms,	dV/dt	20	35	_	V/µs
Critical Rate of Rise of On–State Current (I <sub>PK</sub> = 20 A; Pw = 10 μsec; diG/dt = 1.0 A/μsec, Igt =	20 mA)	di/dt	_	_	50	A/μs

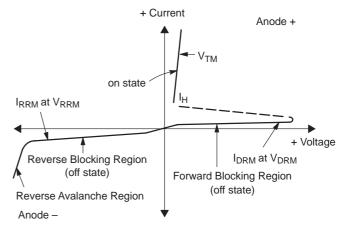
<sup>\*</sup>Indicates Pulse Test: Pulse Width ≤ 1.0 ms, Duty Cycle ≤ 1%.

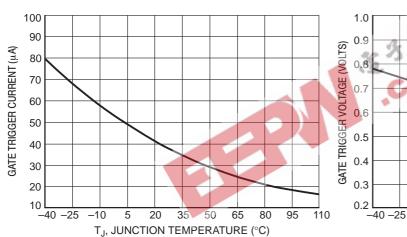
R<sub>GK</sub> = 1000 Ohms included in measurement.
 Does not include R<sub>GK</sub> in measurement.

#### MCR100-8

# **Voltage Current Characteristic of SCR**

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Off State Forward Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Off State Reverse Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
$V_{TM}$	Peak on State Voltage
I <sub>H</sub>	Holding Current





0.9 0.9 0.0,0

Figure 1. Typical Gate Trigger Current versus Junction Temperature

Figure 2. Typical Gate Trigger Voltage versus
Junction Temperature

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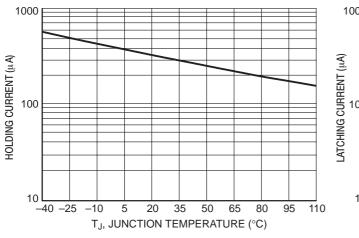


Figure 3. Typical Holding Current versus Junction Temperature

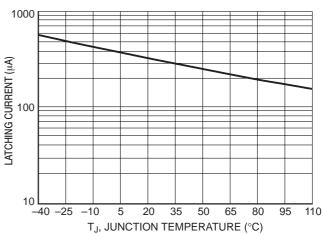


Figure 4. Typical Latching Current versus Junction Temperature

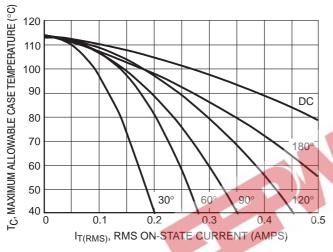


Figure 5. Typical RMS Current Derating

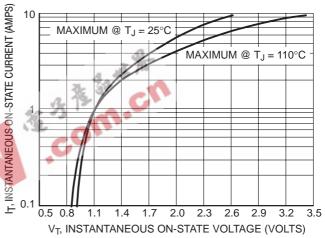


Figure 6. Typical On-State Characteristics